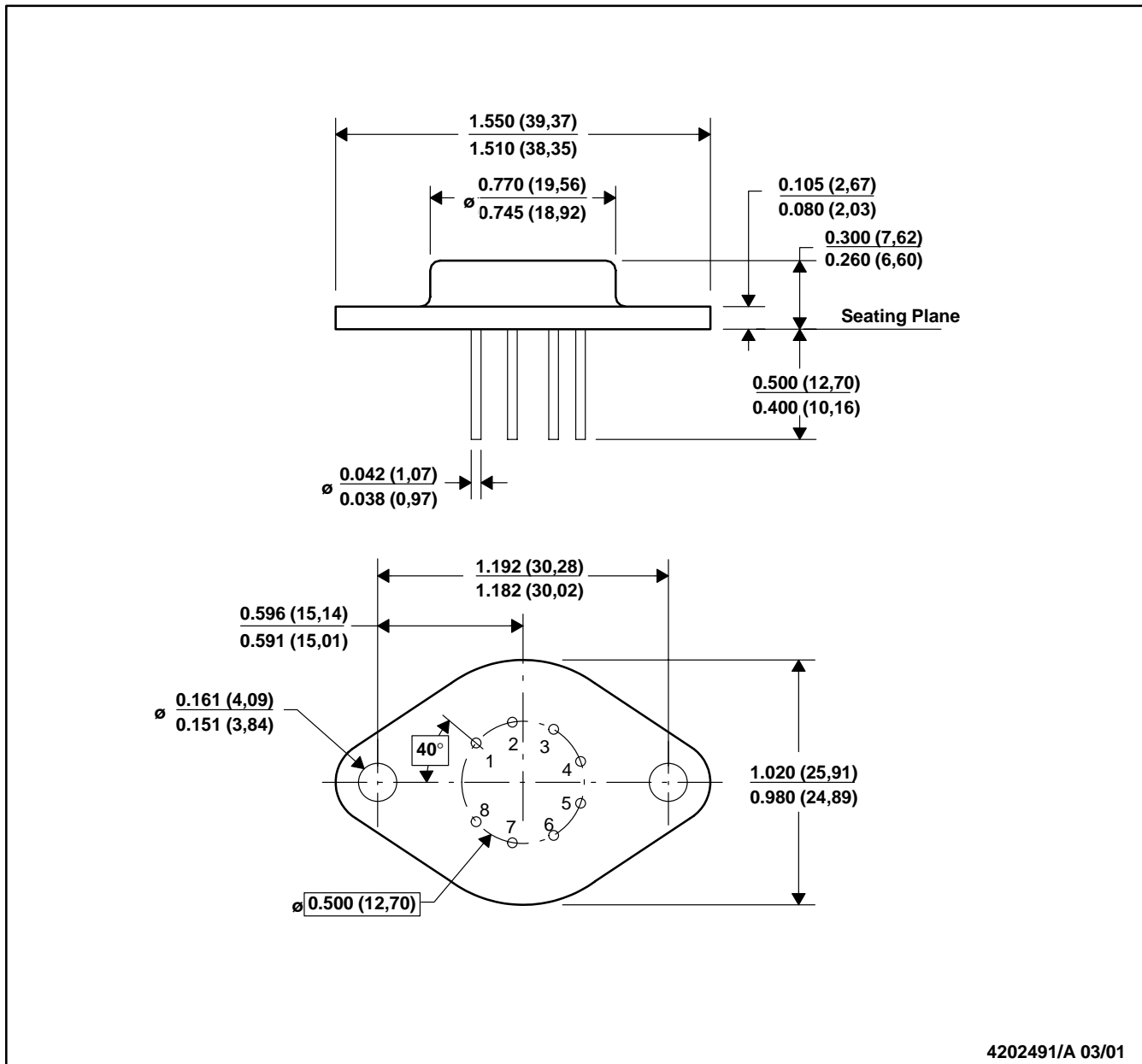


LMF (O-MBCY-W8)

METAL CYLINDRICAL PACKAGE



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Leads in true position within 0.010 (0,25) R @ MMC at seating plane.
 D. Pin numbers shown for reference only. Numbers may not be marked on package.

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